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LPBF of pure copper for particle accelerator applications

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The use of pure copper in accelerators



Lain Amador et al., Electrodeposition of copper applied to the manufacture of seamless superconducting rf cavities A Miniature Linear Accelerator for Cancer Therapy, <u>https://kt.cern/success-stories/miniature-linear-accelerator-cancer-therapy</u> Schietinger et al., Commissioning experience and beam physics measurements at the SwissFEL Injector Test Facility Stancari et al., Conceptual design of hollow electron lenses for beam halo control in the Large Hadron Collider

Mathot et al., The CERN PIXE-RFQ, a transportable proton accelerator for the machina project Scibor et al., PIXE-RFQ modulation and cavity machining Mathot, RFQ vacuum brazing at CERN

The advantages of additive manufacturing

García-Gascón et al., Minimal Surfaces as an Innovative Solution for the Design of an Additive Manufactured Solar-Powered Unmanned Aerial Vehicle (UAV)

Powder bed fusion technologies

Romano & Vedani, Additive Manufacturing of Pure Copper: Technologies and Applications

Copper accelerator components made by powder bed fusion

Sinico et al. (2019), Mayerhofer et al. (2022), Sciacca et al. (2023), Torims et al. (2022) Horn et al. (2018), Lomakin et al. (2019), Nantista et al. (2020), Frigola et al. (2014)

Validation of LPBF for accelerator applications

Material

Chemical purity Microstructure/anisotropy Defects/porosity Mechanical properties Electrical properties

Process

Parameter setting Part orientation Dimensional accuracy Surface roughness Print-to-print reproducibility

Operating conditions

UHV compatibility
High voltage holding
Radio-frequency properties
Response to irradiation
Cryogenic properties

Specimen fabrication

- EOS M 280
- Laser wavelength: 1070 nm
- 99.95% pure Cu powder
- Particle size: 15 38 μm

- TRUMPF TruPrint 1000 Green Edition
- Laser wavelength: 515 nm
- m4pTM PureCu powder (>99.95%)
- Particle size: 10 45 μm

As-printed surface morphology

100 µm

200 µm

Microstructure and hardness

- Oxygen content: 0.041 ± 0.003 wt.%
- Density: ~99.8%
- Microhardness: 78.2 ± 1.9 HV_{0.05}

- Oxygen content: 0.044 ± 0.004 wt.%
- Density: ~99.6%
- Microhardness: 75.5 ± 3.2 HV_{0.05}

Physical properties

High-voltage and UHV testing

Peacock, Experimental Investigation of Vacuum Breakdown Triggering Mechanisms in a DC Electrode System Rorison, A study of the effectiveness of Cold-Spray additive manufacturing for Ultra High Vacuum

Conclusions and future work

Effects of anisotropy on material properties

Surface features produced by breakdown

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Structural features causing

helium leakage

AST

